



Material Content Data Sheet



Sales Product Name				SAK-TC264D-40F200N BC		Issued		20. July 2018	
MA#				MA001672878					
Package				PG-LQFP-144-22		Weight*		1390.32 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	44.943	3.23	3.23	32326	32326	
leadframe	inorganic material	phosphorus	7723-14-0	0.094	0.01		68		
	non noble metal	zinc	7440-66-6	0.377	0.03		271		
	non noble metal	iron	7439-89-6	7.550	0.54		5430		
wire	non noble metal	copper	7440-50-8	306.542	22.05	22.63	220483	226252	
	noble metal	gold	7440-57-5	0.003	0.00		2		
	noble metal	palladium	7440-05-3	0.061	0.00		44		
encapsulation	non noble metal	copper	7440-50-8	2.704	0.19	0.19	1945	1991	
	organic material	carbon black	1333-86-4	2.982	0.21		2145		
	plastics	epoxy resin	-	126.221	9.08		90785		
leadfinish	inorganic material	silicondioxide	60676-86-0	864.660	62.21	71.50	621916	714846	
	noble metal	silver	7440-22-4	0.003	0.00		2		
	noble metal	palladium	7440-05-3	0.004	0.00		3		
plating	noble metal	gold	7440-57-5	0.006	0.00		4		
	non noble metal	nickel	7440-02-0	6.242	0.45	0.45	4490	4499	
	noble metal	silver	7440-22-4	0.010	0.00		7		
glue	noble metal	palladium	7440-05-3	0.012	0.00		8		
	noble metal	gold	7440-57-5	0.019	0.00		14		
	non noble metal	nickel	7440-02-0	18.963	1.36	1.36	13640	13669	
*deviation	plastics	epoxy resin	-	1.963	0.14		1412		
	noble metal	silver	7440-22-4	6.959	0.50	0.64	5005	6417	
						Sum in total:		100.00	1000000

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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